



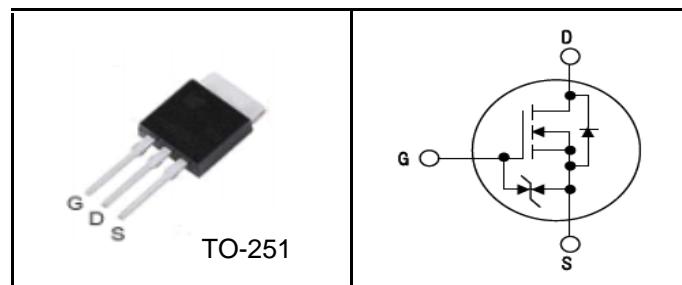
懋昌电源

MPSU70M1K5
Power MOSFET

700V Super-Junction Power MOSFET

Features

- $BV_{DSS}=700\text{ V}$, $I_D=3\text{ A}$
- $R_{DS(on)}:1.5\text{ }\Omega$ (Max) @ $V_{GS}=10\text{ V}$
- Very Low FOM ($R_{DS(on)} \times Q_g$)
- 100% Avalanche Tested
- RoHS compliant



Application

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

RoHS

Device Marking and Package Information

Device	Package	Marking
MPSU70M1K5	TO-251	MP70M1K5

Absolute Maximum Ratings

$T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	700	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D^{(1)}$	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	3.0	A
	Drain Current - Continuous ($T_C = 100^\circ\text{C}$)	1.9	A
$I_{DM}^{(2)}$	Drain Current - Pulsed	8.4	A
$E_{AS}^{(3)}$	Single Pulsed Avalanche Energy	43	mJ
I_{AR}	Avalanche Current	1	A
dv/dt	MOSFET dv/dt ruggedness, $V_{DS}=0\ldots 560\text{V}$	50	V/ns
dv/dt	Reverse diode dv/dt , $V_{DS}=0\ldots 560\text{V}$, $I_{DS} \leq I_D$	15	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	49	W
$V_{ESD(G-S)}$	Gate source ESD(HBM-C=100pF, R=1.5KΩ)	2500	V
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C

Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$	Junction-to-Case	-	2.54	°C/W
$R_{\theta JA}$	Junction-to-Ambient	-	62.5	°C/W



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MPSU70M1K5

Power MOSFET

Electrical Characteristics $T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
On Characteristics						
V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 60 \mu\text{A}$	2.5	-	3.5	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 1.1 \text{ A}$	-	1.35	1.5	Ω
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	700	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 700 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_C = 25^\circ\text{C}$	-	-	1	μA
		$V_{DS} = 700 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_C = 150^\circ\text{C}$	-	-	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 20 \text{ V}$, $V_{DS} = 0 \text{ V}$	-	-	± 1	μA
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	-	245	-	pF
C_{oss}	Output Capacitance		-	13	-	pF
C_{rss}	Reverse Transfer Capacitance		-	1.7	-	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 350 \text{ V}$, $I_D = 1.5 \text{ A}$, $R_G = 25 \Omega$ (Note 4,5)	-	20	-	ns
t_r	Turn-On Rise Time		-	18	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	50	-	ns
t_f	Turn-Off Fall Time		-	20	-	ns
Q_g	Total Gate Charge	$V_{DS} = 560 \text{ V}$, $I_D = 1.5 \text{ A}$, $V_{GS} = 10 \text{ V}$ (Note 4,5)	-	5.5	-	nC
Q_{gs}	Gate-Source Charge		-	1.1	-	nC
Q_{gd}	Gate-Drain Charge		-	2.2	-	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current	-	-	3.0	-	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	-	-	8.4	-	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}$, $I_S = 3.0 \text{ A}$	-	-	1.3	V
trr	Reverse Recovery Time	$V_{GS} = 0 \text{ V}$, $I_S = 1.5 \text{ A}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	135	-	ns
Qrr	Reverse Recovery Charge		-	0.6	-	μC

Notes :

- Limited by T_j max. Maximum duty cycle D=0.50
- Repetitive Rating : Pulse width limited by maximum junction temperature
- $I_{AS}=1\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_j=25^\circ\text{C}$
- Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
- Essentially Independent of Operating Temperature

Typical Characteristics $T = 25^\circ\text{C}$, unless otherwise noted

Figure 1. On Region Characteristics

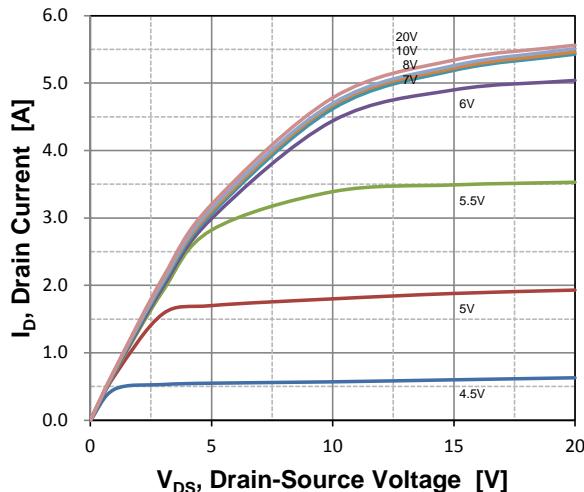


Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage

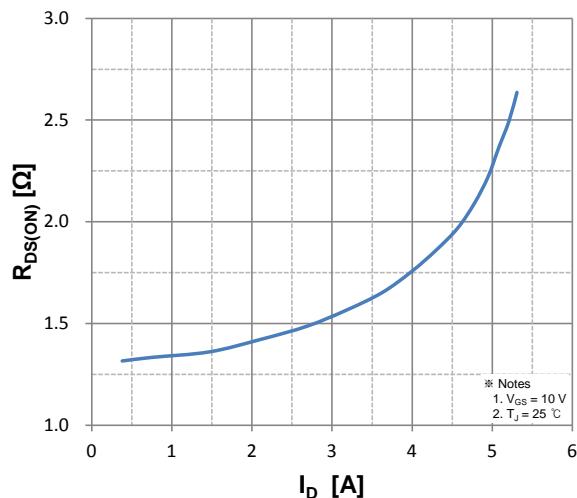


Figure 5. Capacitance Characteristics

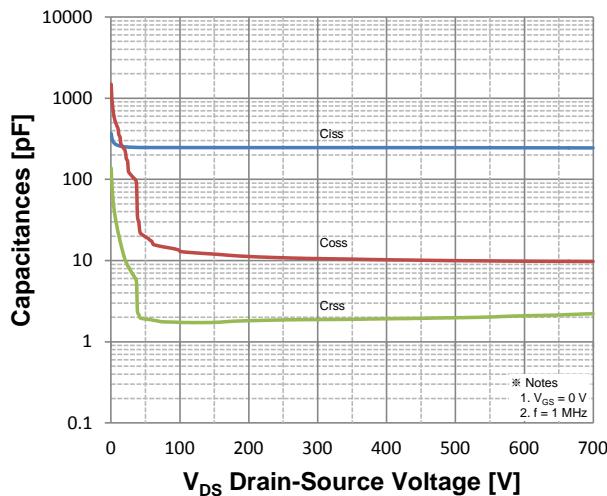


Figure 2. Transfer Characteristics

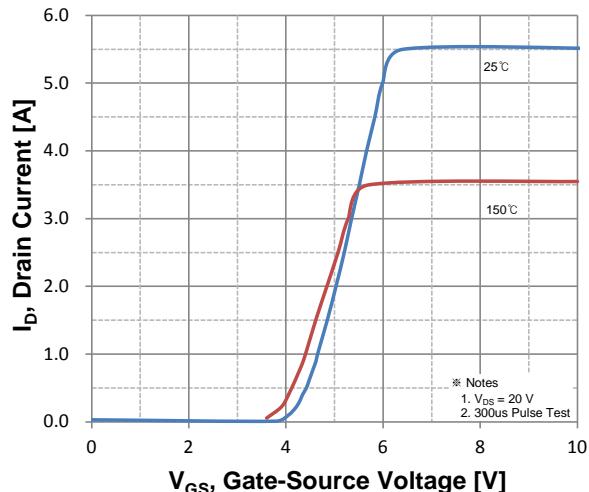


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

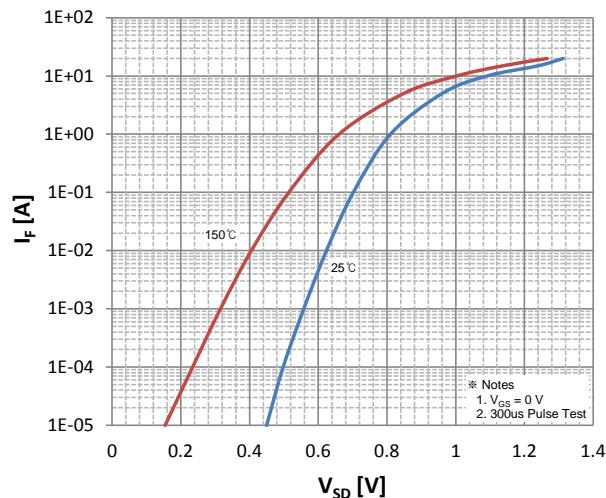
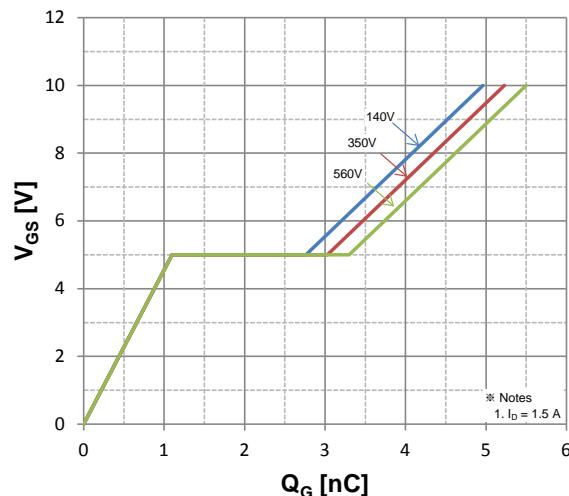


Figure 6. Gate Charge Characteristics



Typical Characteristics $T = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Breakdown Voltage Variation vs. Temperature

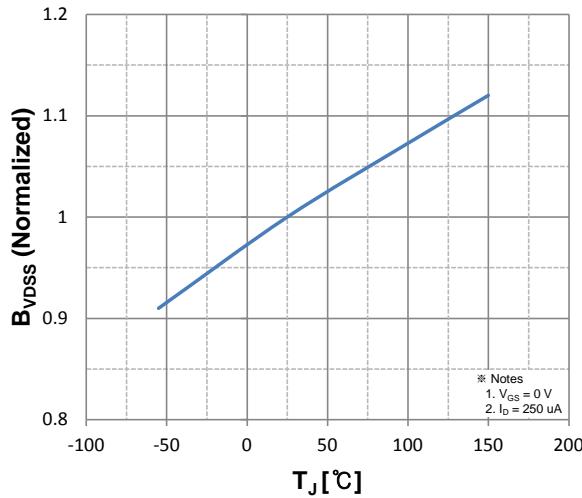


Figure 9. Maximum Safe Operating Area

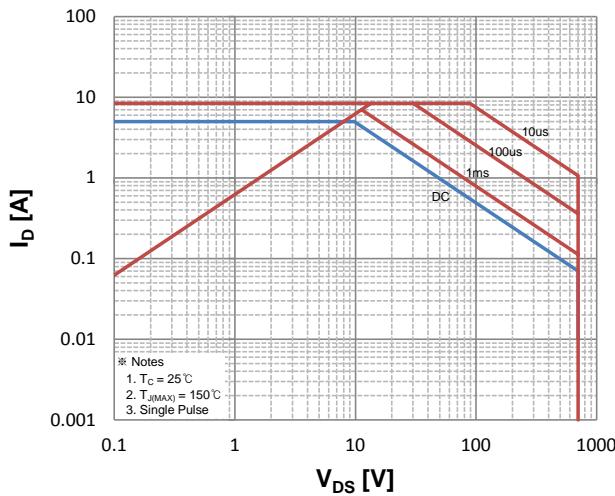


Figure 8. On-Resistance Variation vs. Temperature

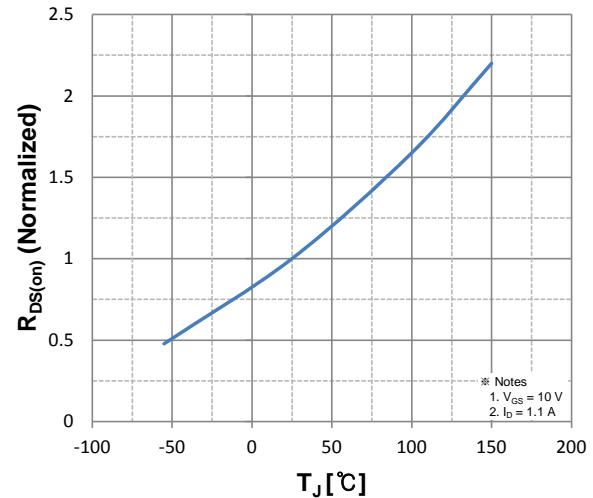


Figure 10. Maximum Drain Current vs. Temperature

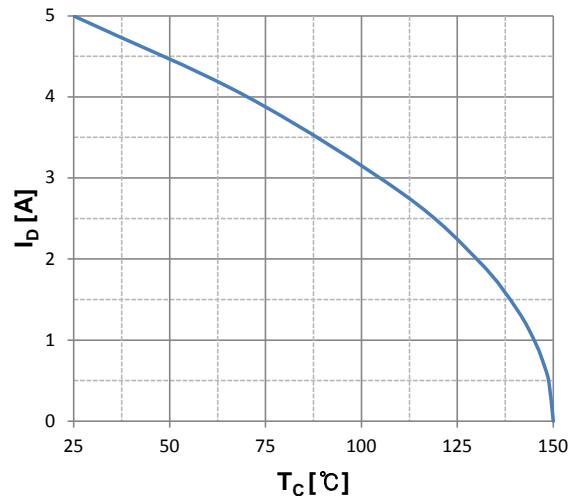


Figure 11. Transient Thermal Response Curve

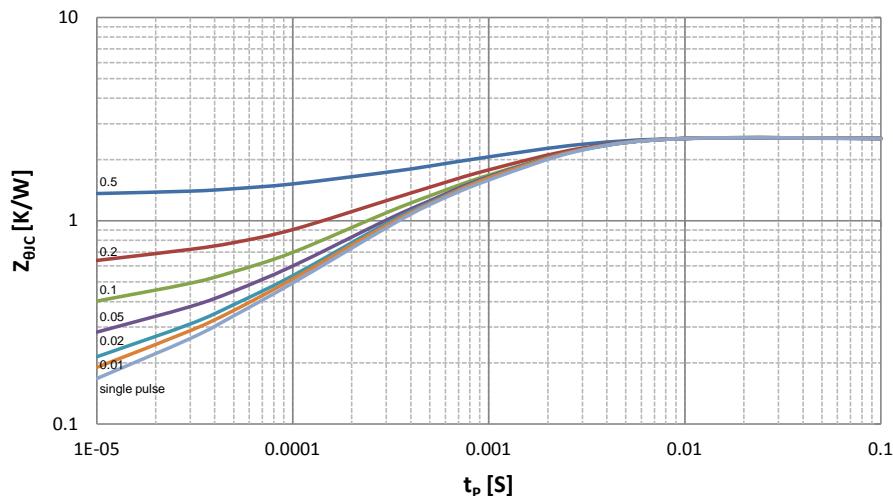


Figure 12. Gate Charge Test Circuit and Waveform

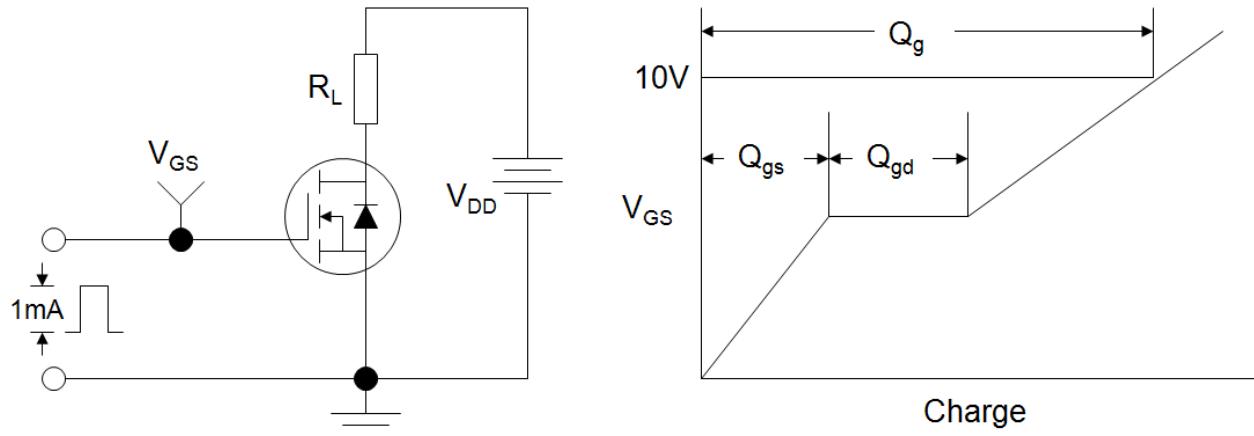


Figure 13. Resistive Switching Test Circuit and Waveform

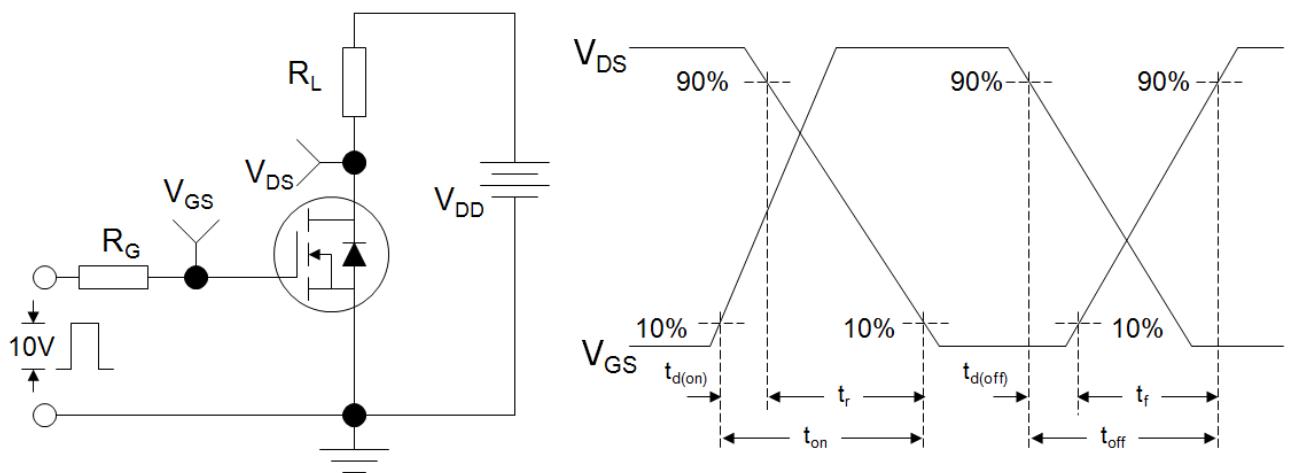
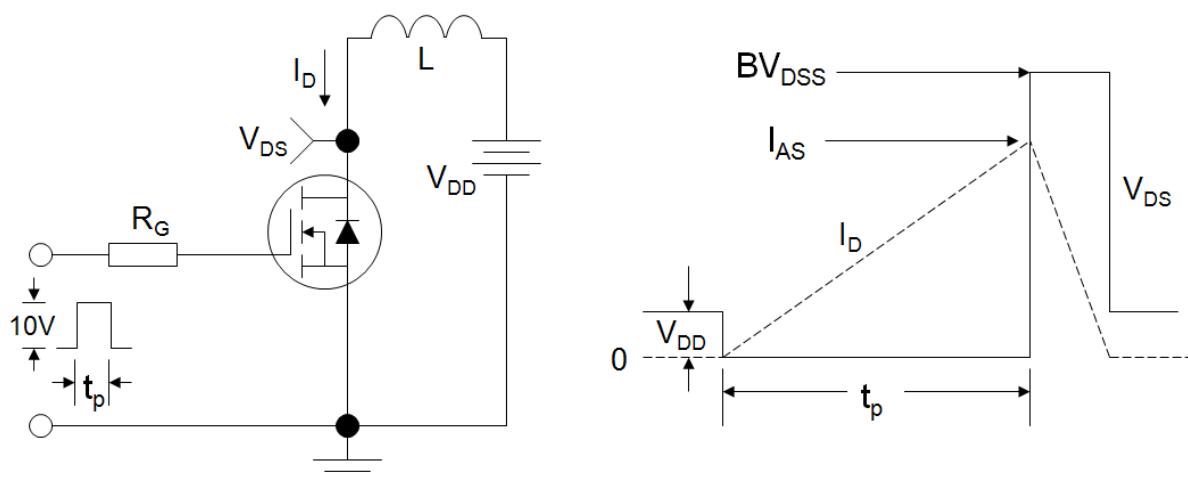


Figure 14. Unclamped Inductive Switching Test Circuit and Waveform

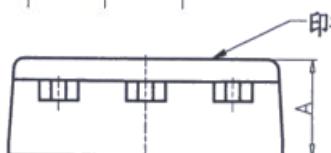
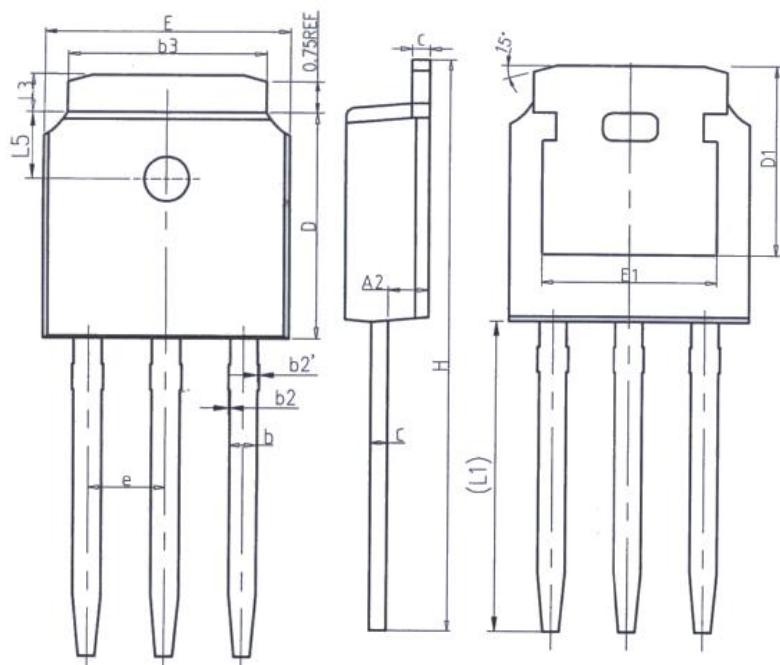




懋喜电源

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TO-251



Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A2	0.97	1.17
b	0.68	0.90
b2	0.00	0.10
b2'	0.00	0.10
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22

Unit: mm		
Symbol	Min.	Max.
D1	5.30REF	
E	6.40	6.80
E1	4.63	-
e	2.286BSC	
H	16.22	16.82
L1	9.15	9.65
L3	0.88	1.28
L5	1.65	1.95